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SKY73021: 1700 – 2200 MHz High Gain and Linearity Diversity Downconversion Mixer for 2G/3G Base Station Transceiver Applications

Applications

- 2G/3G base station transceivers:
 - GSM/EDGE, CDMA, UMTS/WCDMA, PHS
- Land mobile radio
- Wireless Local Loop
- High performance radio links
- Private mobile radio

Features

- Operating frequency range: 1700 to 2200 MHz
- IF frequency range: 40 to 300 MHz
- Conversion gain: 6.0 dB
- Input IP3: 26.0 dBm
- Output IP3: 32.0 dBm
- Noise figure: 9.6 dB
- Integrated LO drivers
- Integrated low loss RF baluns
- High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 50 dB LO-to-LO isolation)
- Small, MCM (36-pin, 6 x 6 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)



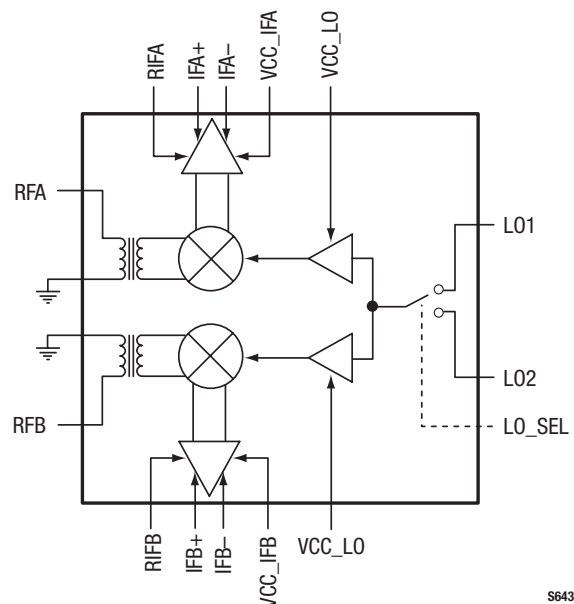
Skyworks offers lead (Pb)-free RoHS (Restriction of Hazardous Substances) compliant packaging.

Description

The SKY73021 is a fully integrated diversity mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73021 features an input IP3 of 26.0 dBm and a Noise Figure (NF) of 9.6 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 50 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73021 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73021 diversity downconversion mixer is provided in a compact, 36-pin 6 x 6 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



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Figure 1. SKY73021 Block Diagram

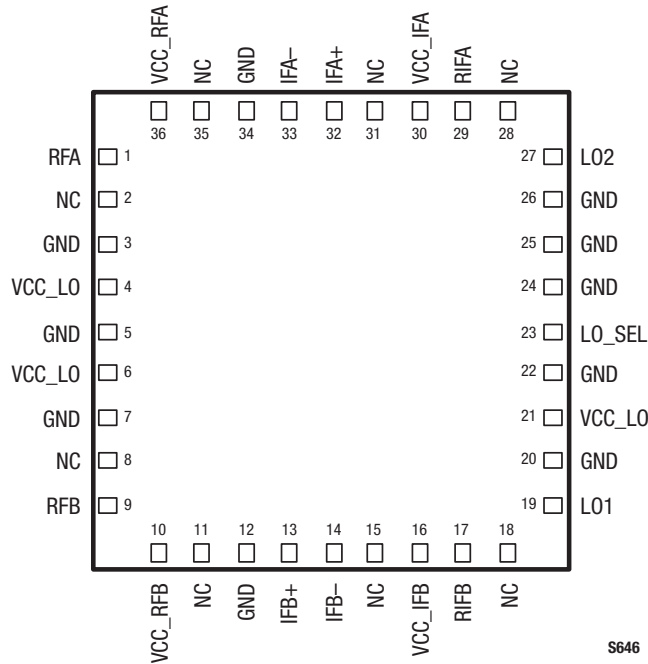


Figure 2. SKY73021 Pinout – 36-Pin MCM

Table 1. SKY73021 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	RFA	Channel A RF input	19	LO1	Local oscillator 1 input
2	NC	No connect	20	GND	Ground
3	GND	Ground	21	VCC_LO	DC supply, +5 V
4	VCC_LO	DC supply, +5 V	22	GND	Ground
5	GND	Ground	23	LO_SEL	Local oscillator select switch control
6	VCC_LO	DC supply, +5 V	24	GND	Ground
7	GND	Ground	25	GND	Ground
8	NC	No connect	26	GND	Ground
9	RFB	Channel B RF input	27	LO2	Local oscillator 2 input
10	VCC_RFB	Channel B RF DC supply, +5 V	28	NC	No connect
11	NC	No connect	29	RIFA	Channel A IF bias adjust
12	GND	Ground	30	VCC_IFA	Channel A IF DC supply, +5 V
13	IFB+	Positive channel B IF output	31	NC	No connect
14	IFB-	Negative channel B IF output	32	IFA+	Positive channel A IF output
15	NC	No connect	33	IFA-	Negative channel A IF output
16	VCC_IFB	Channel B IF DC supply, +5 V	34	GND	Ground
17	RIFB	Channel B IF bias adjust	35	NC	No connect
18	NC	No connect	36	VCC_RFA	Channel A RF DC supply, +5 V

Functional Description

The SKY73021 is a high gain diversity mixer, optimized for base station receiver applications. The device consists of two diversity channels (A and B), each consisting of a low loss RF balun, high linearity passive mixer, and a low noise IF amplifier.

Two LO amplifiers (independent of channels A and B) are also included that allow the SKY73021 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs for frequency hopping applications (i.e., GSM).

RF Baluns and Passive Mixer

The RF baluns provide a single ended input, which can easily be matched to 50 Ω using a simple external matching circuit. The RF baluns offer very low loss, and excellent amplitude and phase balance.

The high linearity SKY73021 is a passive, double balanced mixer that provides a very low conversion loss and an excellent 3rd Order Input Intercept Point (IIP3).

Additionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73021 to be in the range of ±3 dBm. The LO section is optimized for low-side LO injection. However, each of the two LOs can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73021 to be used for frequency hopping applications. This switch provides greater than 50 dB of LO1 to LO2 isolation:

LO_SEL Input	LO Path Selected
High	LO1 (pin 19) enabled
Low	LO2 (pin 27) enabled

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used. An internal pull-down resistor enables the LO2 input.

IF Amplifier

The SKY73021 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the ability to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced 200 Ω impedance. The IF amplifiers are optimized for IF frequencies between 40 and 300 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73021 are provided in Table 2 and the recommended operating conditions in Table 3. Electrical characteristics for the SKY73021 are provided in Table 4.

Typical performance characteristics of the SKY73021 are illustrated in Figures 3 through 35.

Table 2. SKY73021 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage, +5 V (VCC_LO, VCC_RFA, VCC_RFB, VCC_IFA, VCC_IFB)	VCC	4.5	5.5	V
Supply current	I _{CC}		440	mA
RF input power	P _{RF}		20	dBm
LO input power	P _{LO}		20	dBm
Operating case temperature	T _C	-40	+85	°C
Junction temperature	T _J		150	°C
Storage case temperature	T _{STG}	-40	+125	°C

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value.

Nominal thermal resistance (junction to center ground pad) is 5.1 °C/W.

Table 3. SKY73021 Recommended Operating Conditions

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage, +5 V (VCC_LO, VCC_RFA, VCC_RFB, VCC_IFA, VCC_IFB)	VCC	4.75	5.00	5.25	V
Supply current	I _{cc}		380		mA
LO input power	P _{Lo}	-6	0	+6	dBm
LO select input: high low	LO_SELH LO_SELL	2.2		0.8	V V
Operating case temperature	T _c	-40		+85	°C
RF frequency range	F _{RF}	1700		2200	MHz
LO frequency range (Note 1)	F _{Lo}	1460		2000	MHz
IF frequency range	F _{IF}	40		300	MHz

Note 1: The SKY73021 has been optimized for low side LO injection. However, the LO can be used outside of the specified frequency range with degraded performance.

Table 4. SKY73021 Electrical Specifications (1 of 2)

(Voltage Supply = +5 V, T_c = +25 °C, LO = 0 dBm, RF Frequency = 1750 MHz, IF Frequency = 201 MHz, LO Frequency = 1549 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Conversion gain	G		5.6	6.0	6.6	dB
Gain versus temperature		-40 to +85 °C		±0.7		dB
Noise Figure	NF			9.6	10.9	dB
Noise Figure versus temperature		-40 to +85 °C		±0.8		dB
Noise Figure with a blocker signal	NF _{BLK}	Blocking signal input power = +8 dBm		21	23	dB
Third order input intercept point	IIP3	F _{RF} = 1750.0 MHz and 1750.8 MHz, P _{RF} = -10 dBm/tone	25.0	26.0		dBm
Third order input intercept point versus temperature		-40 to +85 °C		±0.6		dB
Third order output intercept point	OIP3	F _{RF} = 1750.0 MHz and 1750.8 MHz, P _{RF} = -10 dBm/tone		32.0		dBm
2RF – 2LO	2x2	P _{RF} = -10 dBm		-66	-57	dBc
3RF – 3LO	3x3	P _{RF} = -10 dBm		-80		dBc
Input 1 dB compression point	IP1dB		15.5	17.0		dBm
Output 1 dB compression point	OP1dB			22.0		dBm
LO1-to-LO2 isolation			40	50		dB
Channel-to-channel isolation			30	47		dB
RF-to-IF-isolation			30	66		dB

Table 4. SKY73021 Electrical Specifications (2 of 2)

(Voltage Supply = +5 V, T_c = +25 °C, LO = 0 dBm, RF Frequency = 1750 MHz, IF Frequency = 201 MHz, LO Frequency = 1549 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
LO leakage: @ RF port @ IF port				-41 -50	-24 -27	dBm dBm
LO_SEL input			-20	+150	+250	μA
LO switching time					0.5	μs
RF port input return loss	Z _{in_rf}	With external matching components	14			dB
LO port input return loss	Z _{in_lo}	With external matching components	14			dB
IF port input return loss	Z _{out_if}	With external matching components	14			dB

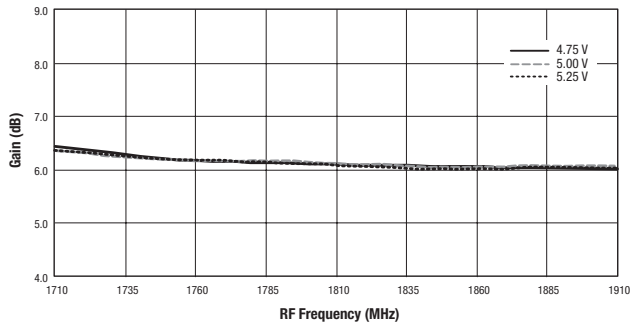


Figure 3. Mixer A Gain vs Frequency and Supply Voltage

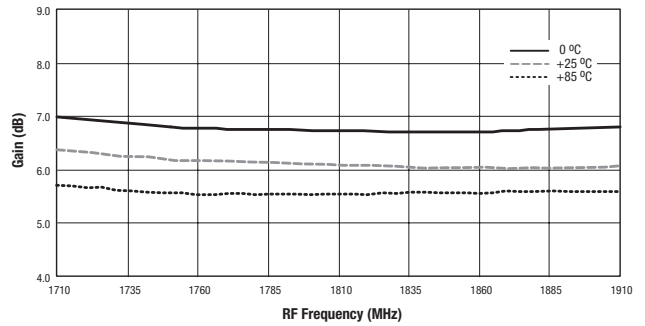


Figure 4. Mixer A Gain vs Frequency and Temperature

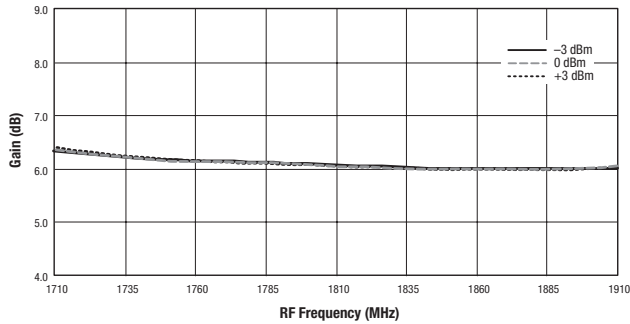


Figure 5. Mixer A Gain vs Frequency and LO Power

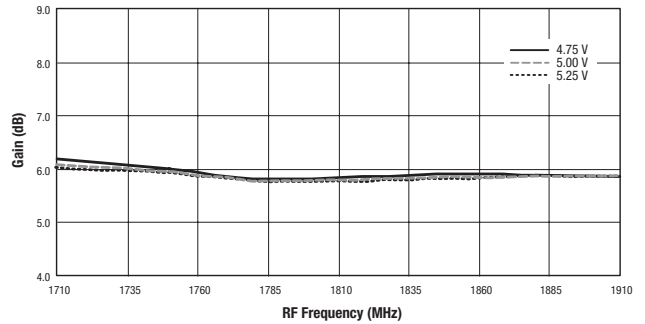


Figure 6. Mixer B Gain vs Frequency and Supply Voltage

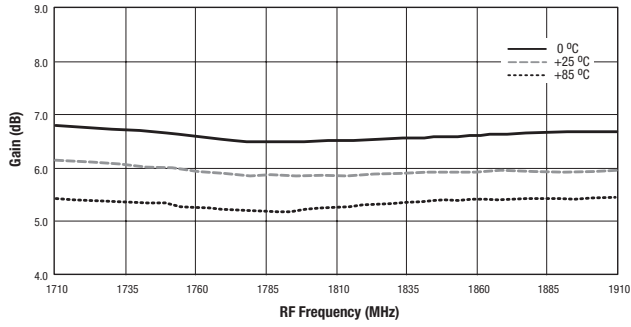


Figure 7. Mixer B Gain vs Frequency and Temperature

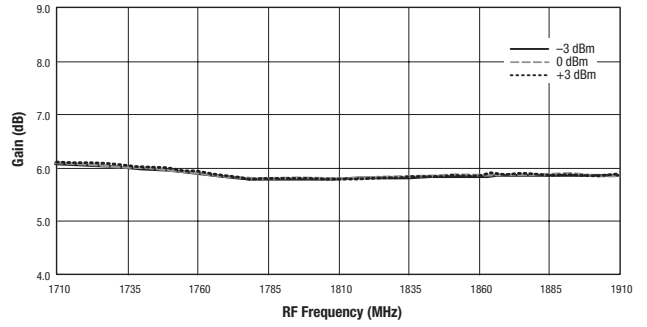


Figure 8. Mixer B Gain vs Frequency and LO Power

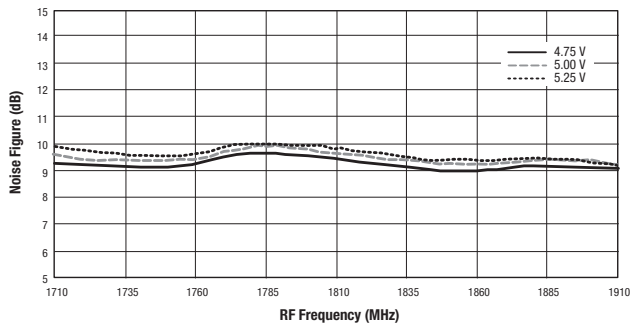


Figure 9. Mixer A Noise Figure vs Frequency and Supply Voltage

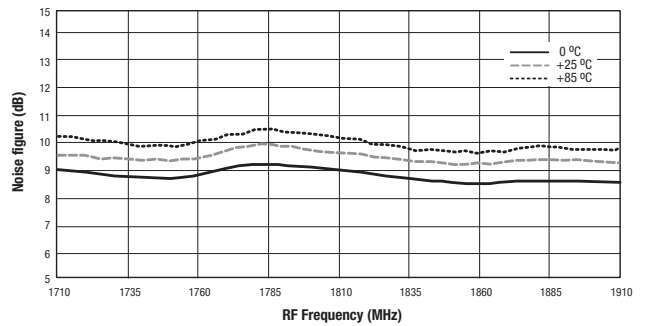


Figure 10. Mixer A Noise Figure vs Frequency and Temperature

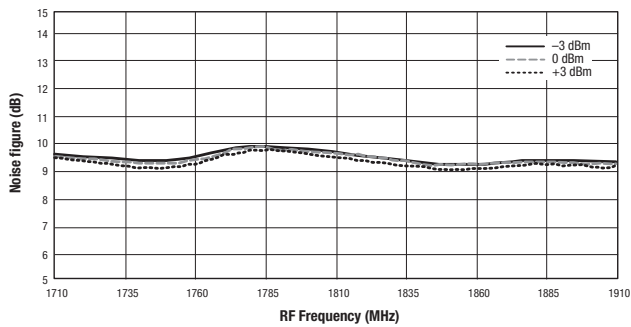


Figure 11. Mixer A Noise Figure vs Frequency and LO Power

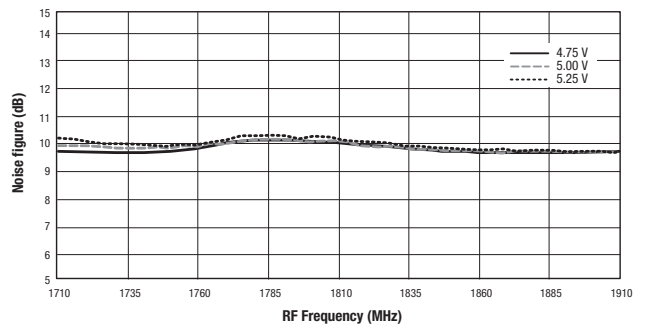


Figure 12. Mixer B Noise Figure vs Frequency and Supply Voltage

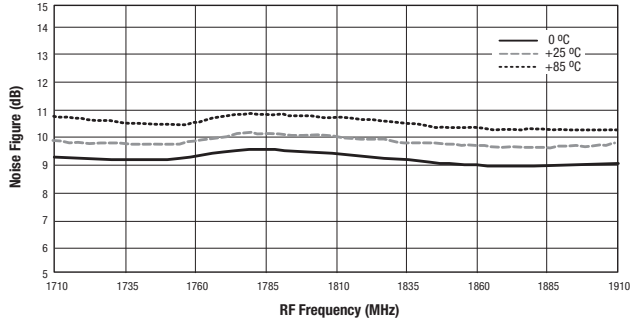


Figure 13. Mixer B Noise Figure vs Frequency and Temperature

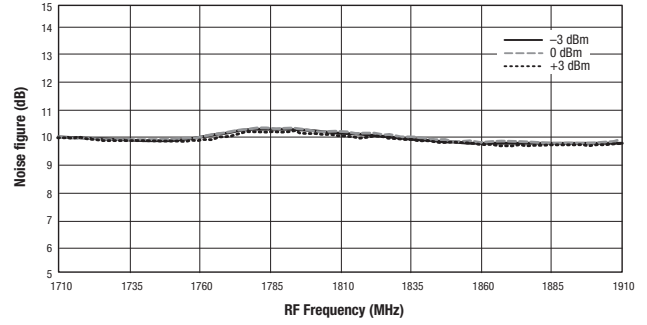


Figure 14. Mixer B Noise Figure vs Frequency and LO Power

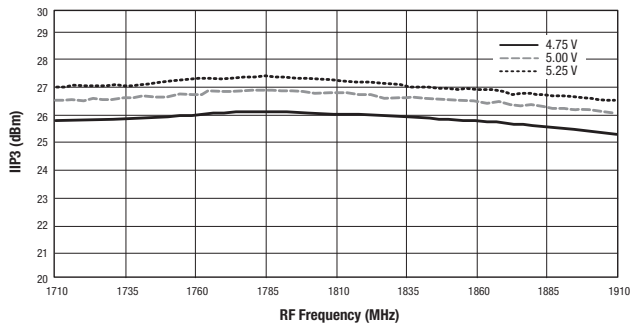


Figure 15. Mixer A IIP3 vs Frequency and Supply Voltage

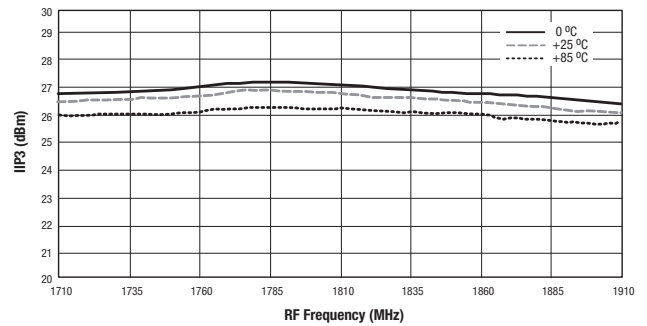


Figure 16. Mixer A IIP3 vs Frequency and Temperature

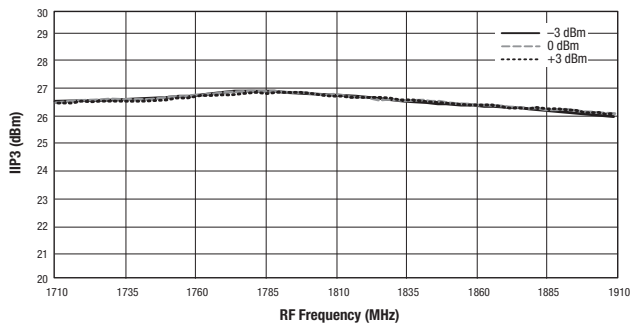


Figure 17. Mixer A IIP3 vs Frequency and LO Power

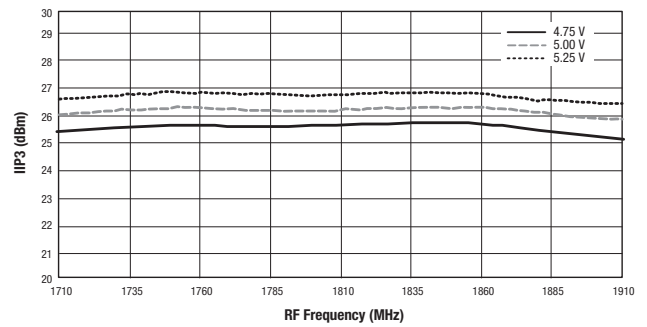


Figure 18. Mixer B IIP3 vs Frequency and Supply Voltage

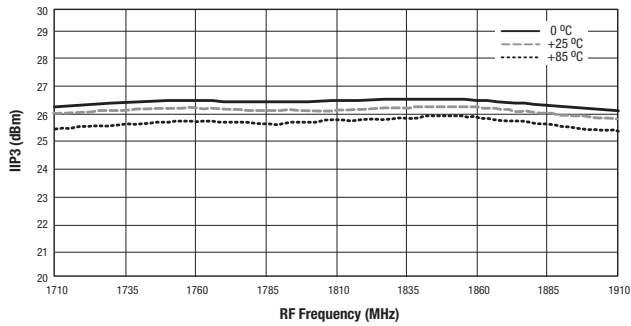


Figure 19. Mixer B IIP3 vs Frequency and Temperature

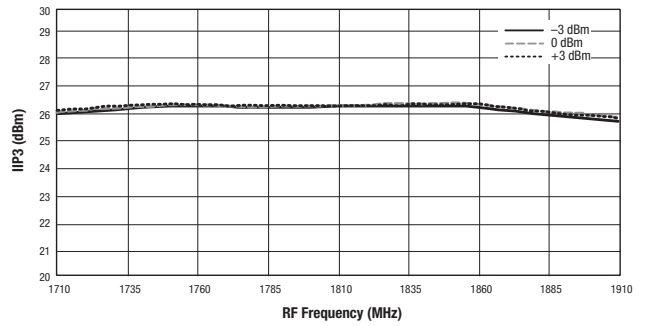


Figure 20. Mixer B IIP3 vs Frequency and LO Power

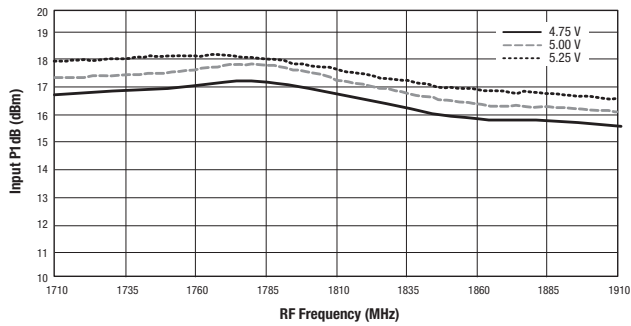


Figure 21. Mixer A Input P1dB vs Frequency and Supply Voltage

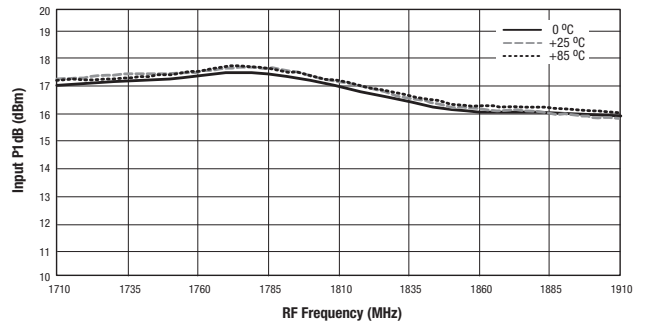


Figure 22. Mixer A Input P1dB vs Frequency and Temperature

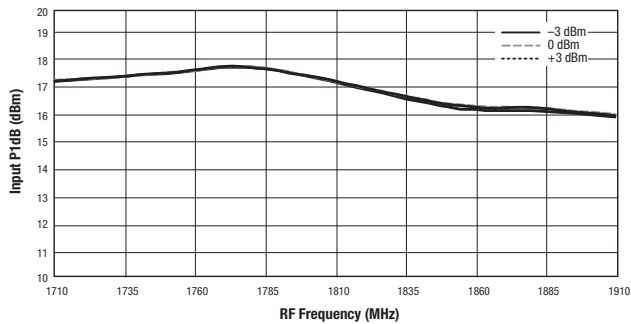


Figure 23. Mixer A Input P1dB vs Frequency and LO Power

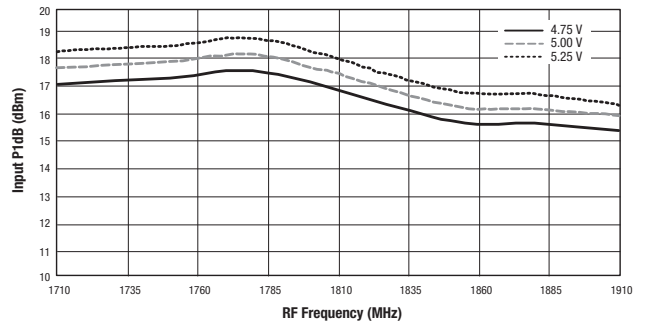


Figure 24. Mixer B Input P1dB vs Frequency and Supply Voltage

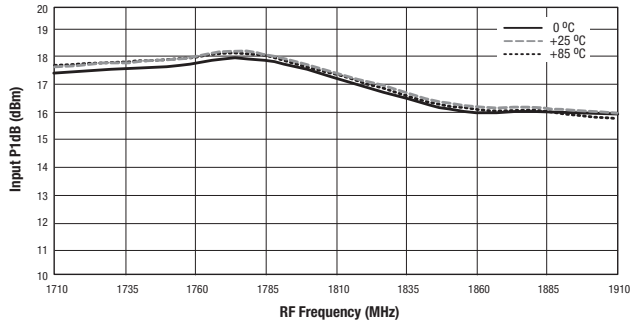


Figure 25. Mixer B Input P1dB vs Frequency and Temperature

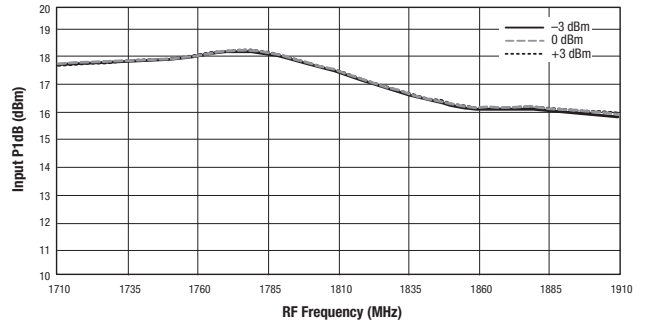


Figure 26. Mixer B Input P1dB vs Frequency and LO Power

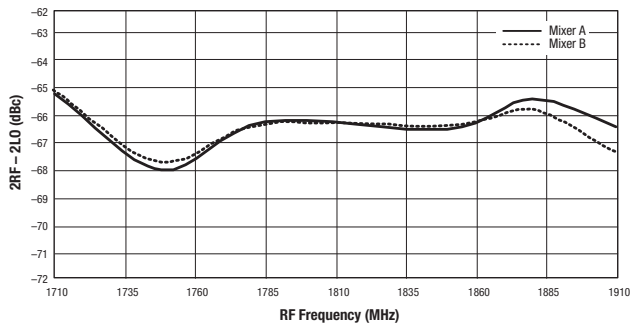


Figure 27. Mixer A and B 2RF - 2LO vs Frequency

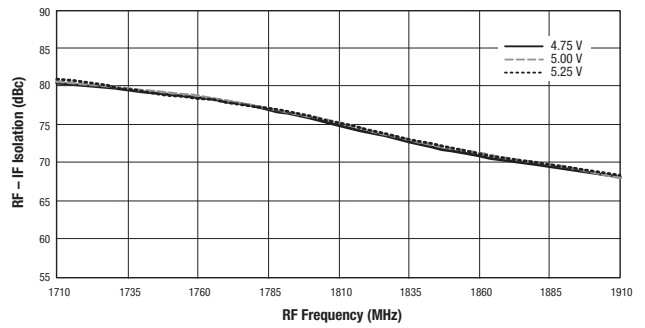


Figure 28. Mixer A RF to IF Isolation vs Frequency and Supply Voltage

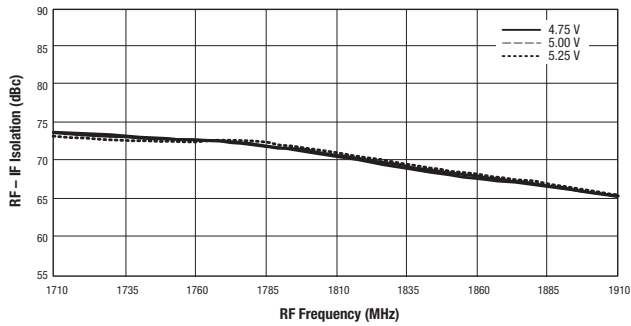


Figure 29. Mixer B RF to IF Isolation vs Frequency and Supply Voltage

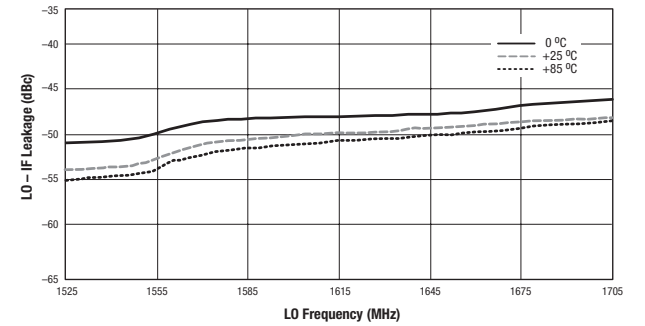


Figure 30. Mixer A LO to IF Leakage vs Frequency and Temperature

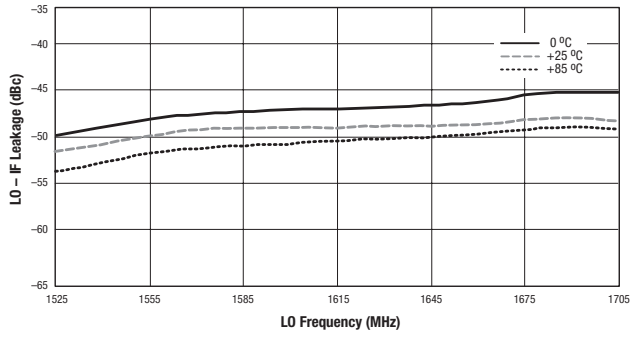


Figure 31. Mixer B LO to IF Leakage vs Frequency and Temperature

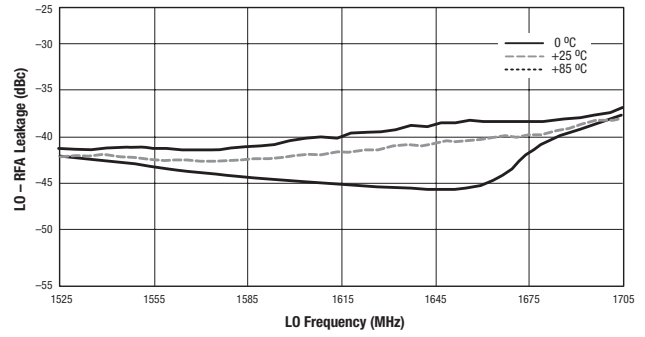


Figure 32. Mixer A LO to RF Leakage vs Frequency and Temperature

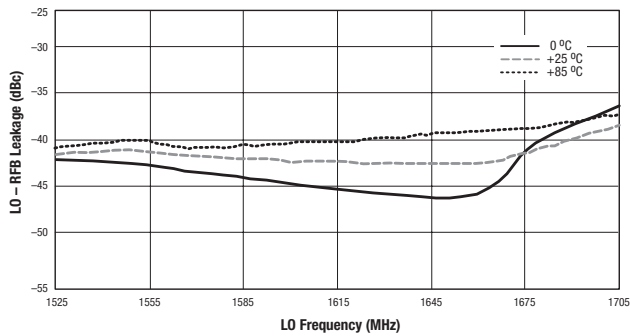


Figure 33. Mixer B LO to RF Leakage vs Frequency and Temperature

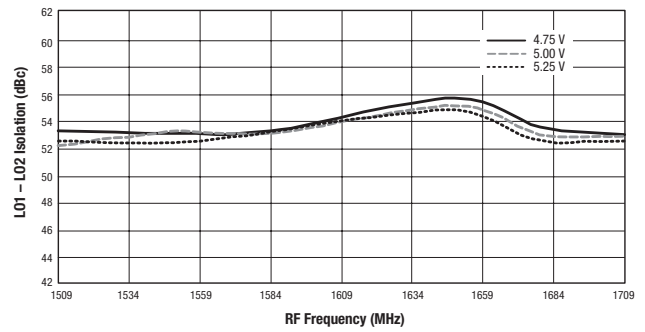


Figure 34. L01 to L02 Isolation vs Frequency and Supply Voltage

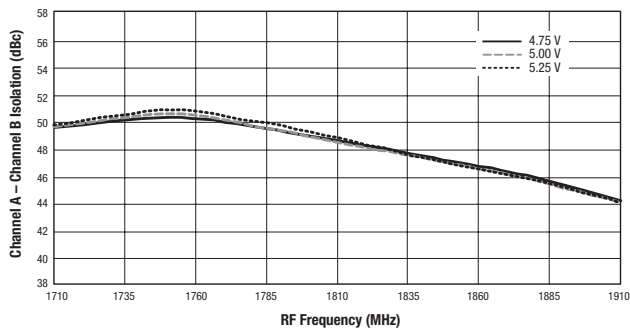


Figure 35. Channel A to Channel B IF Isolation vs Frequency and Supply Voltage

Evaluation Board Description

The SKY73021 Evaluation Board is used to test the performance of the SKY73021 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 36 and the layer detail is provided in Figure 37.

Circuit Design Configurations

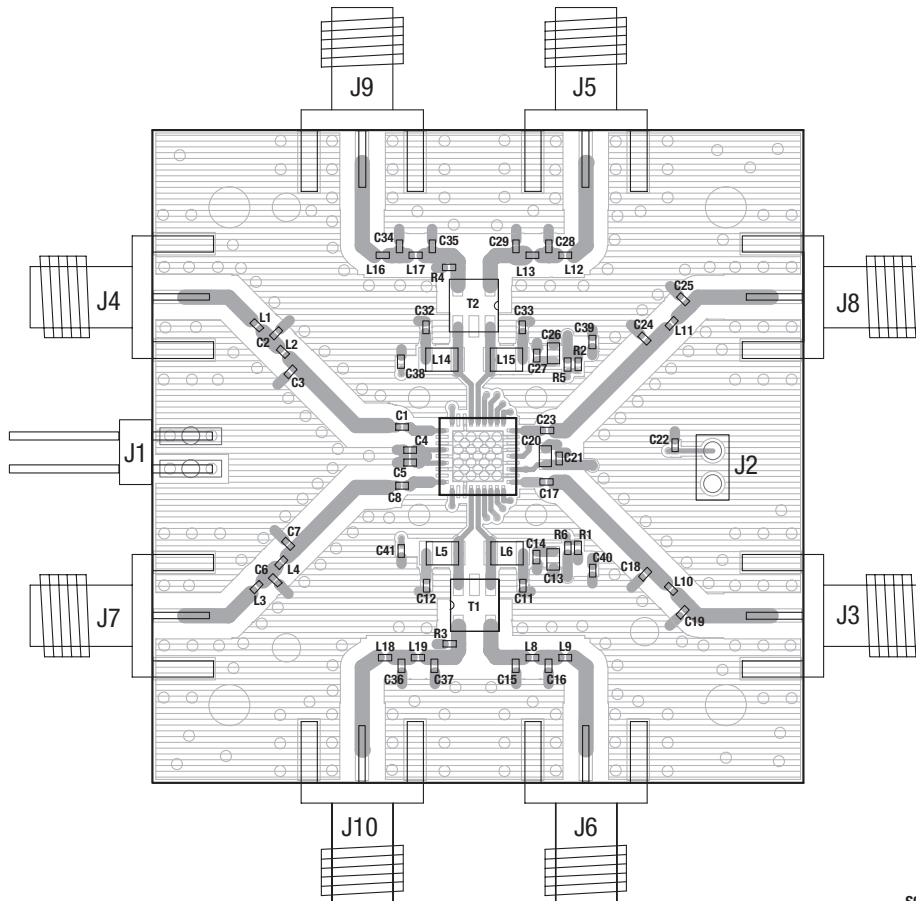
The following design considerations are general in nature and must be followed regardless of final use or configuration:

1. Paths to ground should be made as short and as low impedance as possible.
2. The ground pad of the SKY73021 provides critical electrical and thermal functionality. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground

pad to dissipate the maximum heat produced by the circuit board. For more information on soldering the SKY73021, refer to the Package and Handling Information section of this Data Sheet.

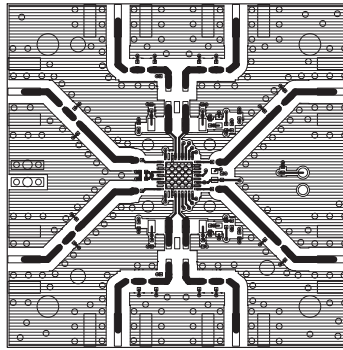
3. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device.
4. Components L5, L6, L14, and L15 (see Figure 38) are high-Q, low loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.
5. Components R1 and R2 (see Figure 38) allow for external adjustment of the IF amplifier bias points. For operation as specified in Tables 3 and 4, these resistors are not required.

A schematic diagram for the SKY73021 Evaluation Board is shown in Figure 38.

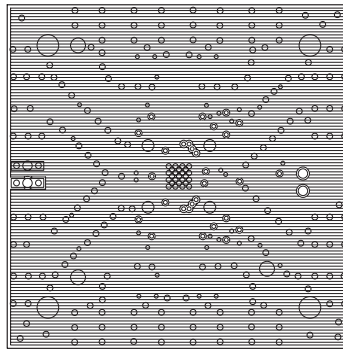


S905

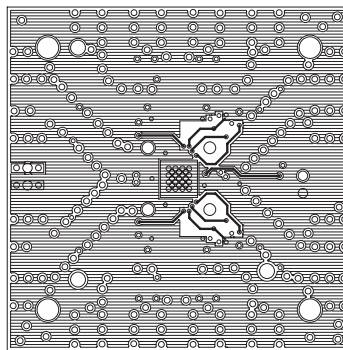
Figure 36. SKY73021 Evaluation Board Assembly Diagram



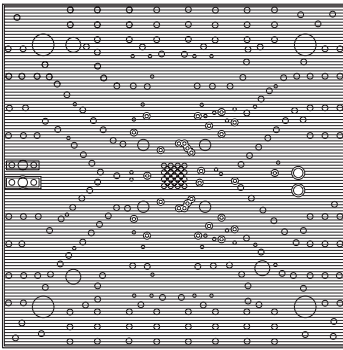
Layer 1: Top -- Metal



Layer 2: Ground



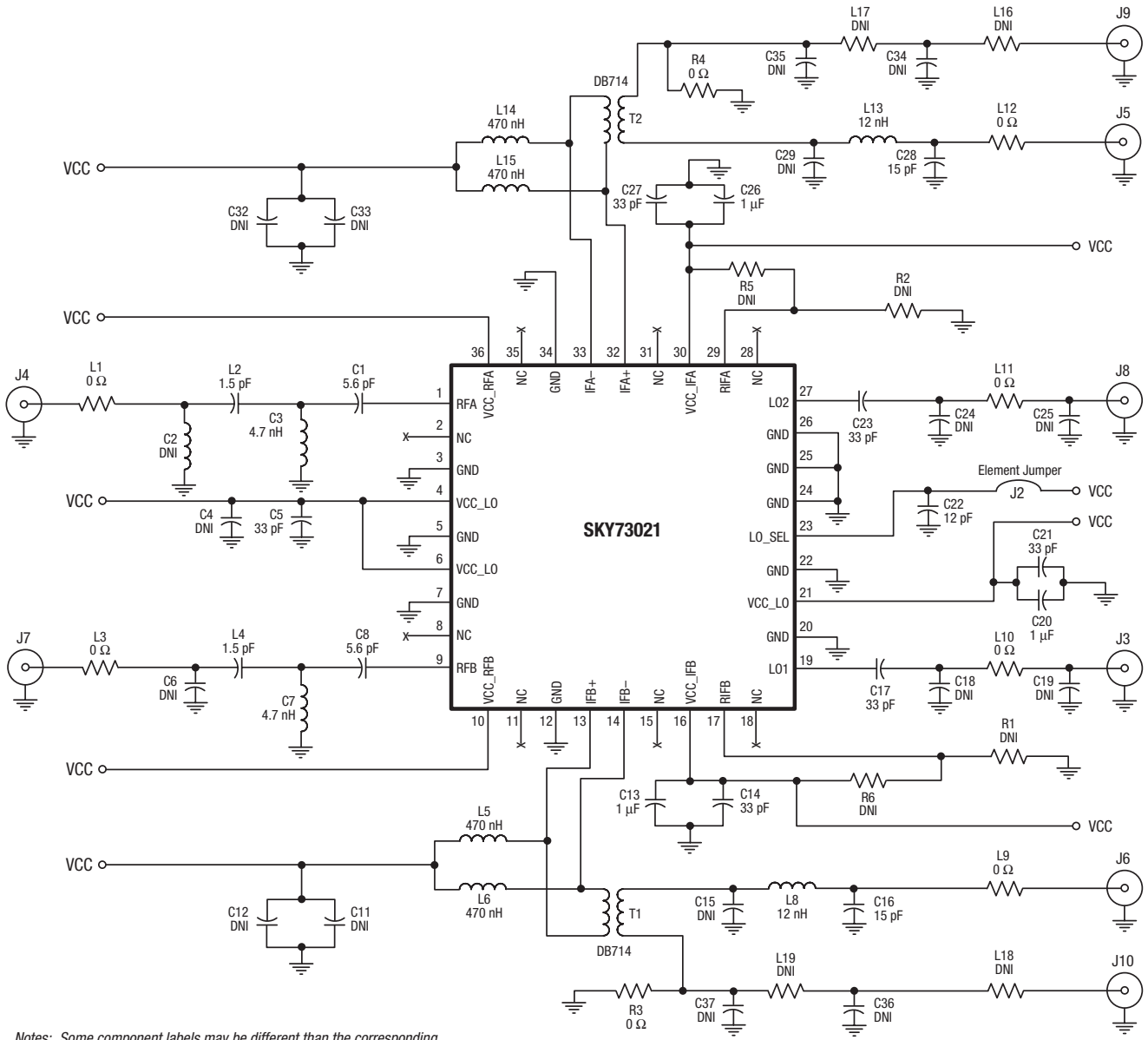
Layer 3: Power Plane



Layer 4: Solid Ground Plane

S904

Figure 37. SKY77021 Evaluation Board Layer Detail



Notes: Some component labels may be different than the corresponding component symbol shown here. Component values, however, are accurate as of the date of this Data Sheet.

The Evaluation Board can be converted to provide a differential output by removing components T1, T2, R3, and R4.

S1161

Figure 38. SKY73021 Evaluation Board Schematic

Package Dimensions

The PCB layout footprint for the SKY73021 is provided in Figure 39. Figure 40 shows the package dimensions for the 36-pin MCM, and Figure 41 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

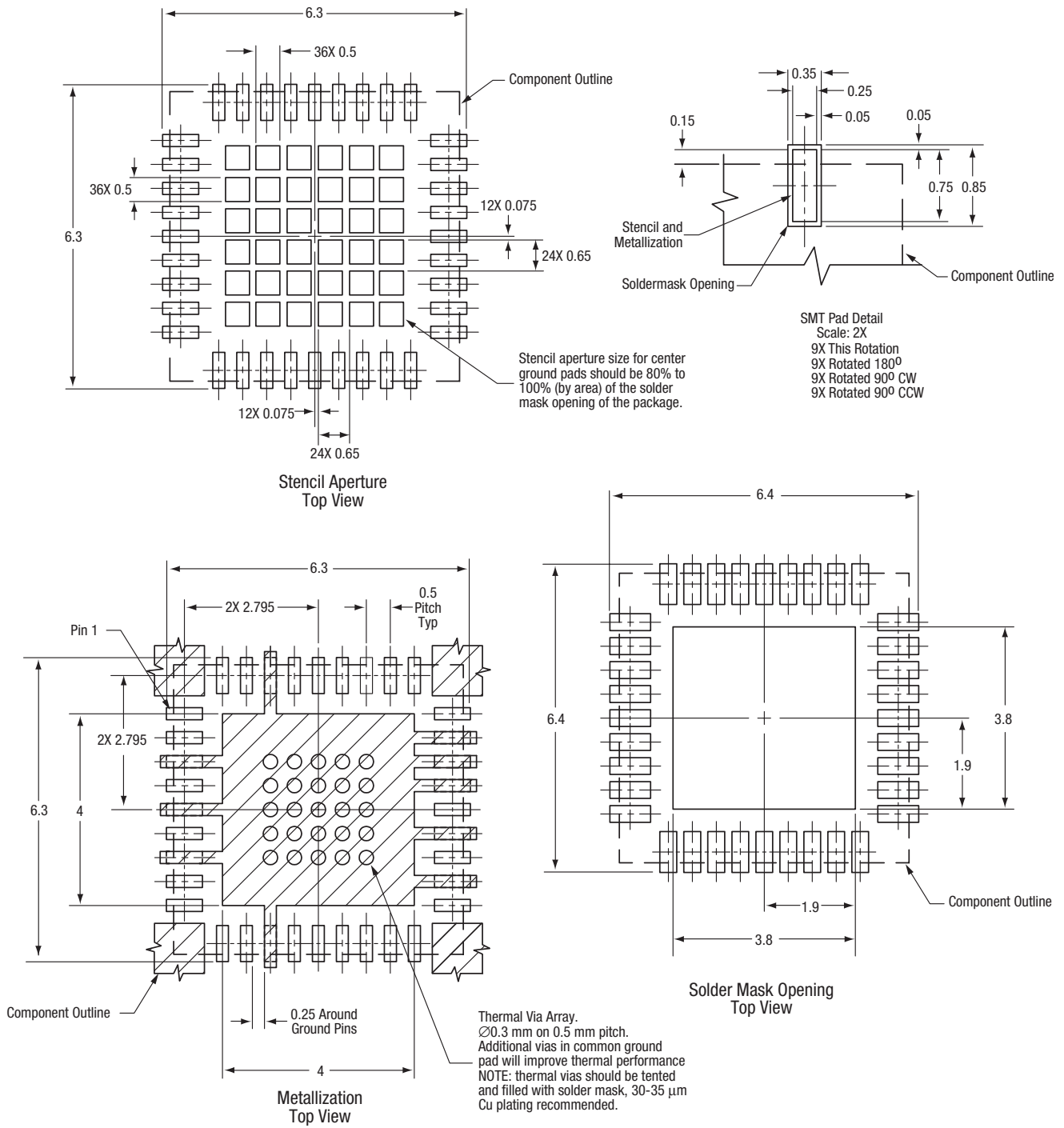
THE SKY73021 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For

additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

The SKY73021 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

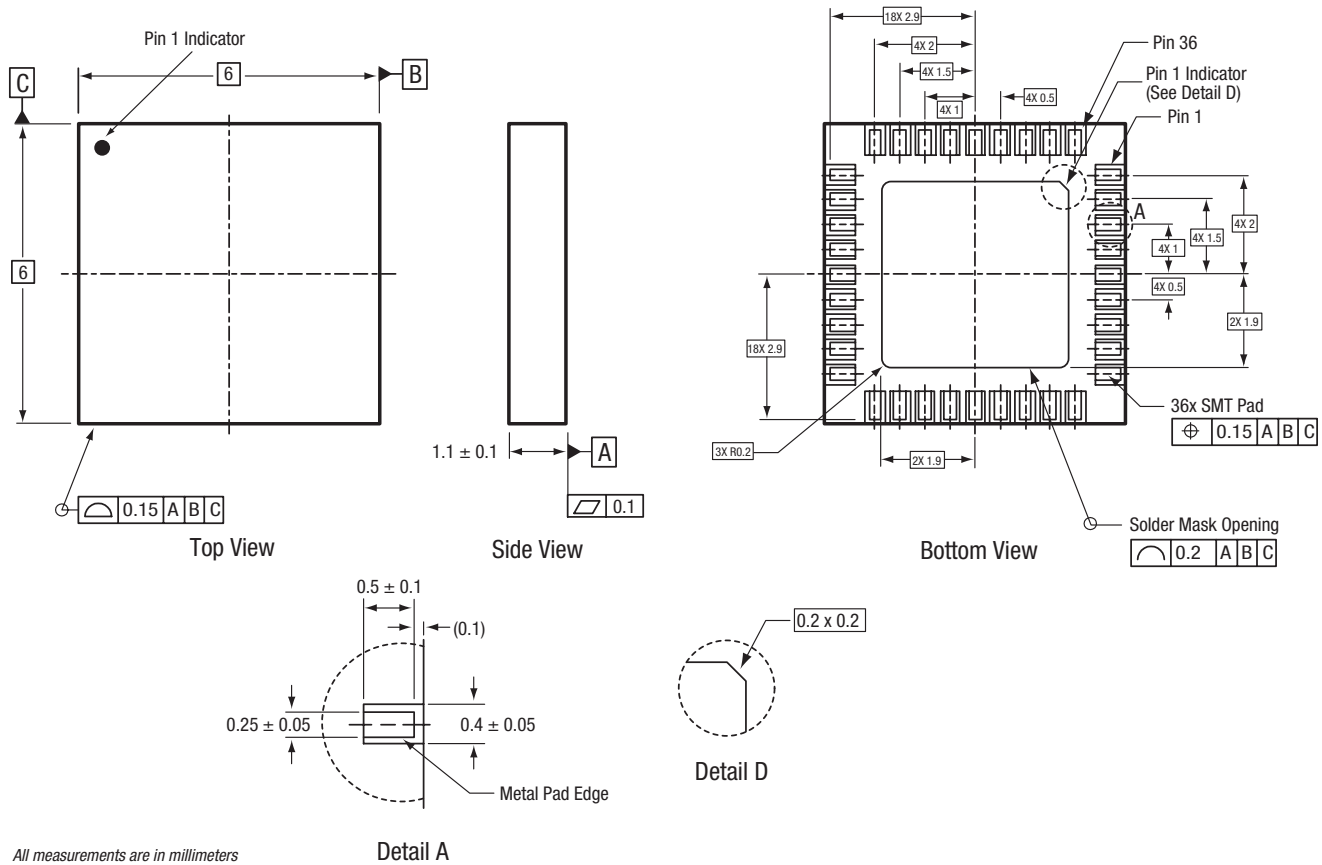


Note: The cross-hatched area represents the merger of the center ground pad + 10 individual I/O ground pads. All I/O ground pads should have at least one via connected to internal ground planes for optimum electrical performance.

All measurements are in millimeters

S1125

Figure 39. PCB Layout Footprint for the SKY73021 6 x 6 mm MCM



All measurements are in millimeters

Pads are solder mask defined on one edge and metal defined on three edges.

Dimensioning and tolerancing according to ASME Y14.5M-1994

S689_A

Figure 40. SKY73021 36-Pin MCM Package Dimensions

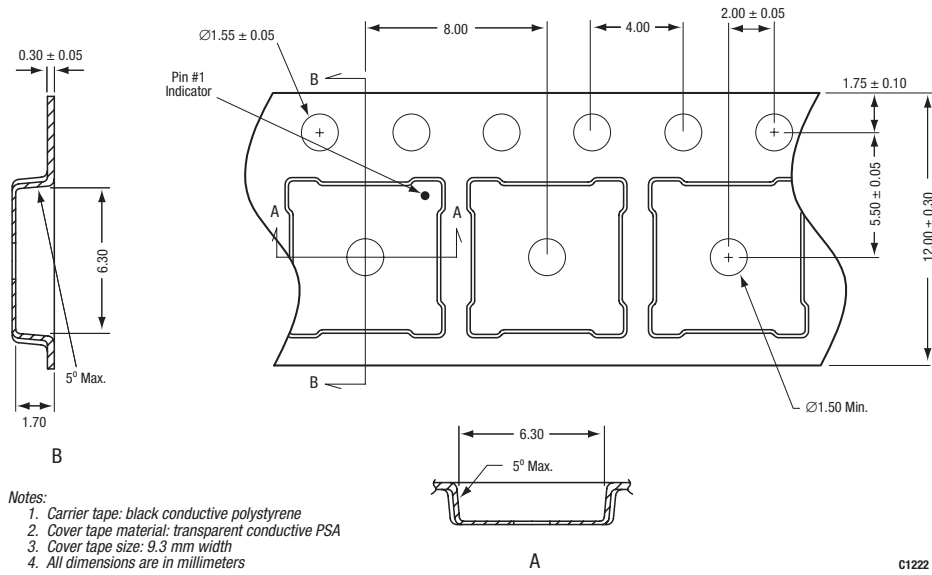


Figure 41. SKY73021 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY73021 Downconversion Mixer	SKY73021-11 (Pb-free package)	TW16-D670

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